

NCE N-Channel Super Trench II Power MOSFET

Description

The NCEP068N10G uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

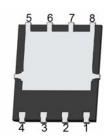
General Features

- V_{DS} =100V,I_D =85A
 - $R_{DS(ON)}$ =6.1m Ω (typical) @ V_{GS} =10V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 150 °C operating temperature
- Pb-free lead plating

100% UIS TESTED! 100% ΔVds TESTED!

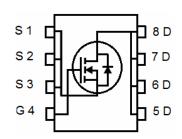
DFN 5X6





Top View

Bottom View



Schematic Diagram

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
P068N10G	NCEP068N10G	DFN5X6-8L	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	100	V
Gate-Source Voltage	V _G s	±20	V
Drain Current-Continuous	I _D	85	А
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	61	А
Pulsed Drain Current	I _{DM}	340	Α
Maximum Power Dissipation	P _D	105	W
Derating factor		0.84	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	320	mJ
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 150	$^{\circ}$ C

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	$R_{ heta JC}$	1.2	°C/W



Electrical Characteristics (T_C=25 °C unless otherwise noted)

V _{GS} =0V I _D =250μA V _{DS} =100V,V _{GS} =0V V _{GS} =±20V,V _{DS} =0V V _{DS} =V _{GS} ,I _D =250μA V _{GS} =10V, I _D =40A F=1.0MHz	100	3.3	- 1 ±100	V μA nA
V _{DS} =100V,V _{GS} =0V V _{GS} =±20V,V _{DS} =0V V _{DS} =V _{GS} ,I _D =250μA V _{GS} =10V, I _D =40A	2	-	1	μA
V _{GS} =±20V,V _{DS} =0V V _{DS} =V _{GS} ,I _D =250μA V _{GS} =10V, I _D =40A	2	-		•
V _{DS} =V _{GS} ,I _D =250μA V _{GS} =10V, I _D =40A	2	<u> </u>	±100	nA
V _{GS} =10V, I _D =40A		33		
V _{GS} =10V, I _D =40A		3 3		
		5.5	4	V
F=1.0MHz	-	6.1	6.8	mΩ
		1.3		Ω
$V_{DS}=5V,I_{D}=40A$		60	-	S
•	•			
\/ 50\/\\ 0\/	-	3600	-	PF
	-	335	-	PF
F=1.UWIFIZ	-	19.5	-	PF
•	•			
	-	16	-	nS
V _{DD} =50V,I _D =40A	-	11	-	nS
V_{GS} =10V, R_{G} =3 Ω	-	35	-	nS
	-	9	-	nS
\/ _E0\/ _40A	-	60	-	nC
	-	20		nC
V _{GS} =10V	-	15		nC
	1		•	
V _{GS} =0V,I _S =40A	-		1.2	V
	-	-	85	Α
T. = 25°C L= = 404	-	45	-	nS
1J - 25 C, IF - 40A				
	V _{GS} =10V,R _G =3Ω V _{DS} =50V,I _D =40A, V _{GS} =10V	V _{DS} =50V,V _{GS} =0V, F=1.0MHz - V _{DD} =50V,I _D =40A - V _{GS} =10V,R _G =3Ω V _{DS} =50V,I _D =40A, V _{GS} =10V	V _{DS} =50V,V _{GS} =0V, F=1.0MHz - 335 - 19.5 - 16 - 16 - 11 - 16 - 11 - 35 - 9 - 9 - 60 - 9 - 60 - 20 - 15 - 15	V _{DS} =50V,V _{GS} =0V, F=1.0MHz - 335 - 19.5 - 19.5 16 - 16 - 11 - 11 - 11 - 11 - 11 -

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\text{C}$,V $_{\text{DD}}$ =50 V,V $_{\text{G}}$ =10 V,L=0.5 mH,Rg=25 Ω



Typical Electrical and Thermal Characteristics

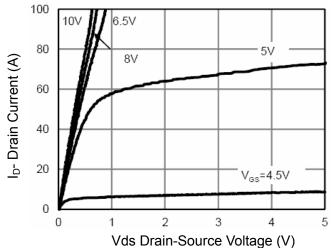


Figure 1 Output Characteristics

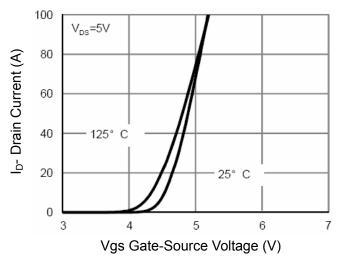


Figure 2 Transfer Characteristics

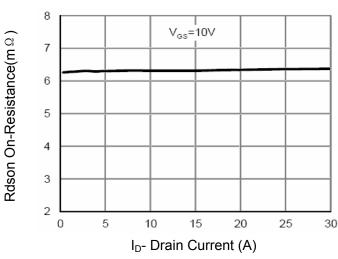


Figure 3 Rdson- Drain Current

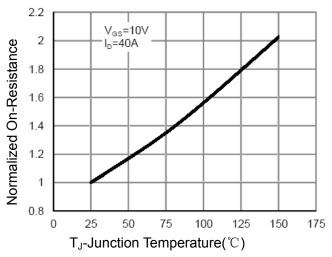


Figure 4 Rdson-Junction Temperature

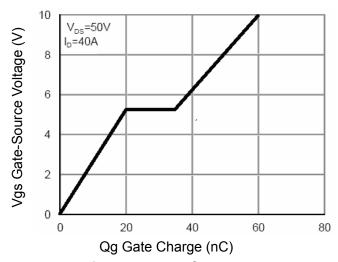


Figure 5 Gate Charge

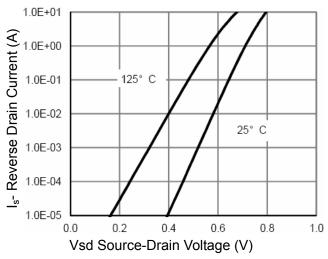
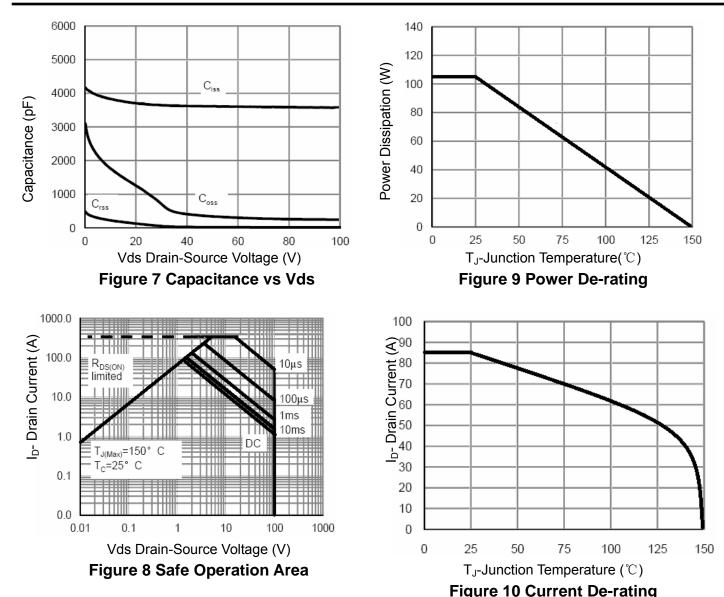


Figure 6 Source- Drain Diode Forward





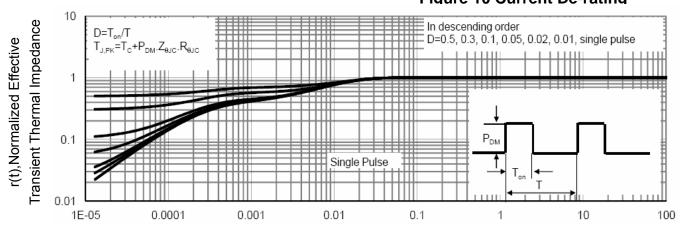
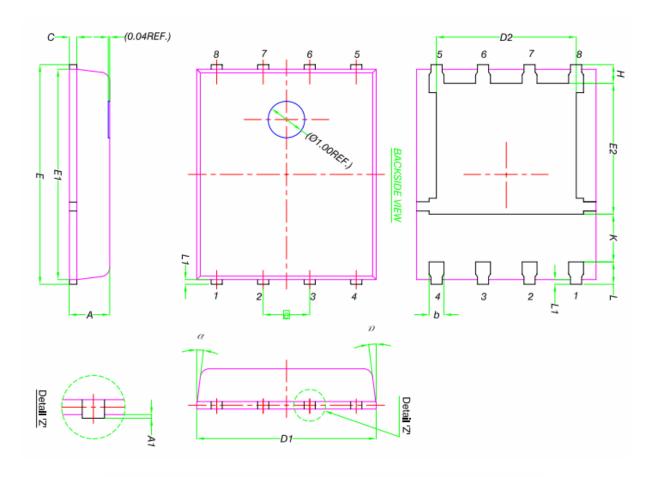


Figure 11 Normalized Maximum Transient Thermal Impedance

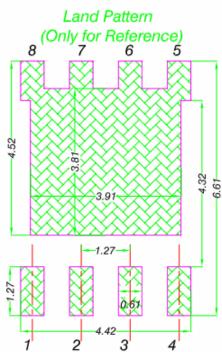
Square Wave Pluse Duration(sec)



DFN5X6-8L Package Information



DIM	MILLIMETERS			
DIM.	MIN.	NOM.	MAX.	
Α	0.90	1.00	1.10	
A1	0	-	0.05	
b	0.33	0.41	0.51	
С	0.20	0.25	0.30	
D1	4.80	4.90	5.00	
D2	3.61	3.81	3.96	
Ε	5.90	6.00	6.10	
E1	5.70	5.75	5.80	
E2	3.38	3.58	3.78	
е				
Н	0.41	0.51	0.61	
K	K 1.10		-	
L	0.51	0.61	0.71	
L1	L1 0.06		0.20	
α	<i>0</i> °	-	12°	



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NCEP068N10G

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